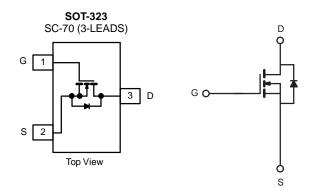


AM1340N-T1-PF-VB Datasheet

N-Channel 20 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | |
| | 0.036 at V_{GS} = 10 V | 4 | | | | |
| 20 | 0.040 at V _{GS} = 4.5 V | 3.8 | 4 nC | | | |
| | 0.048 at V _{GS} = 2.5 V | 3.6 | | | | |



FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Portable Devices
 - Load Switch
 - Battery Switch
- · Load Switch for Motors, Relays and Solenoids

| Parameter | | Symbol | Limit | Unit |
|--|------------------------|-----------------------------------|----------------------|------|
| Drain-Source Voltage | | V _{DS} | 20 | V |
| Gate-Source Voltage | | V _{GS} | ± 12 | v |
| | T _C = 25 °C | | 4 ^a | |
| Continuous Drain Current (T 150 °C) | T _C = 70 °C | | 3.6 ^a | |
| Continuous Drain Current ($T_J = 150 \ ^{\circ}C$) | T _A = 25 °C | I _D | 4 ^{a, b, c} | |
| | T _A = 70 °C | | 3.7 ^{b, c} | A |
| Pulsed Drain Current (t = 300 µs) | | I _{DM} | 20 | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | 2.3 ^a | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 1.3 ^{b, c} | |
| | T _C = 25 °C | | 2.8 | |
| Maximum Power Dissipation | T _C = 70 °C | | 1.8 | w |
| | T _A = 25 °C | P _D | 1.56 ^{b, c} | vv |
| | T _A = 70 °C | | 1.0 ^{b, c} | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stq} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | | | |
|---|--------------|-------------------|---------|------|------|--|--|--|
| Parameter | Symbol | Typical | Maximum | Unit | | | | |
| Maximum Junction-to-Ambient ^{b, d} | t ≤ 5 s | R _{thJA} | 60 | 80 | °C/W | | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 34 | 45 | C/W | | | |

Notes:

a. Package limited, $T_C = 25$ °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 °C/W.

COMPLIANT HALOGEN

FREE



| SPECIFICATIONS ($T_J = 25 \text{ °C}$, unless otherwise noted) | | | | | | | |
|---|-------------------------|--|------|-------|-------|--------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | • | • | | • | • | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 20 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | 1 250 1 | | 23 | | m\//°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | - I _D = 250 μA | | - 3.2 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 0.6 | | 1.3 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 4.5 V$ | | | ± 0.5 | | |
| | | $V_{DS} = 0 V, V_{GS} = \pm 12 V$ | | | ± 25 | μA | |
| Zara Cata Valtaga Drain Current | | $V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$ | | | 10 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$ | 15 | | | А | |
| | | V _{GS} = 10 V, I _D = 3.7 A | | 0.036 | | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 4.5 V, I _D = 3.6 A | | 0.040 | | | |
| | | V _{GS} = 2.5 V, I _D = 1.5 A | | 0.048 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 3.7 A | | 17 | | S | |
| Dynamic ^b | | · | | | | | |
| Tatal Cata Charge | Qg | $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$ | | 8.8 | 13.5 | nC | |
| Total Gate Charge | | | | 4 | 6 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$ | | 0.9 | | | |
| Gate-Drain Charge | Q _{gd} | | | 1.1 | | | |
| Gate Resistance | Rg | f = 1 MHz | 0.4 | 2 | 4 | kΩ | |
| Turn-On Delay Time | t _{d(on)} | | | 0.29 | 0.58 | - | |
| Rise Time | t _r | V _{DD} = 15 V, R _L = 4.1 Ω | | 0.4 | 0.8 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \approx 3.7$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$ | | 1.9 | 3.8 | | |
| Fall Time | t _f | 1 | | 0.75 | 1.5 | | |
| Turn-On Delay Time | t _{d(on)} | | | 0.1 | 0.2 | μs | |
| Rise Time | t _r | V _{DD} = 15 V, R _I = 4.1 Ω | | 0.15 | 0.3 | - | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \approx 3.7 \text{ Å}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$ | | 3 | 6 | | |
| Fall Time | t _f | 1 | | 0.75 | 1.5 | | |
| Drain-Source Body Diode Characteristic | cs | | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | 2.3 | ^ | |
| Pulse Diode Forward Current | I _{SM} | | | | 20 | A | |
| Body Diode Voltage | V _{SD} | $I_{\rm S}$ = 3.7 A, $V_{\rm GS}$ = 0 V | | 0.85 | 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 12 | 25 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | TI _F = 3.7 A, dl/dt = 100 A/μs, T _J = 25 °C | | 5 | 10 | nC | |
| Reverse Recovery Fall Time | ta | | | 6.5 | | | |
| Reverse Recovery Rise Time | t _b | | | 5.5 | | ns | |

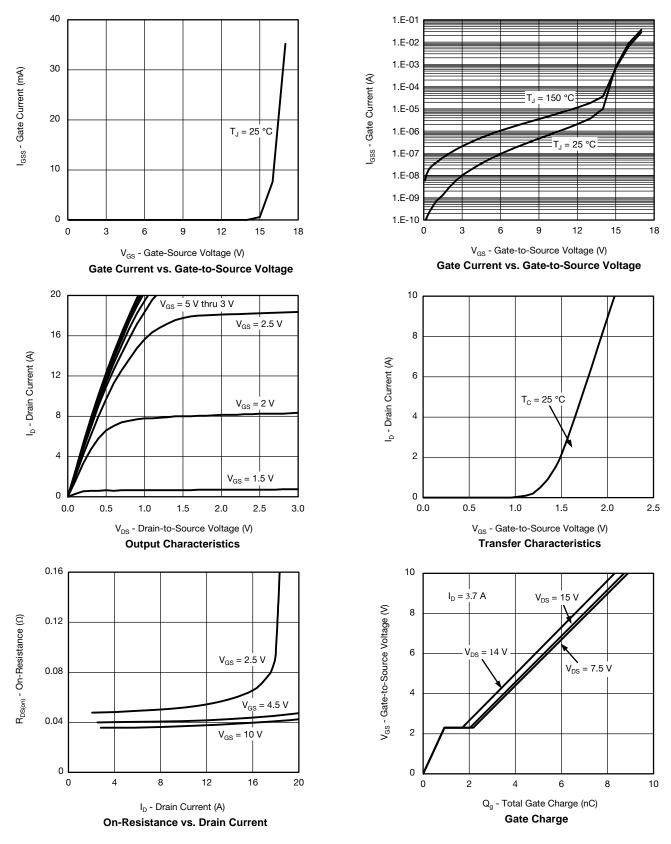
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

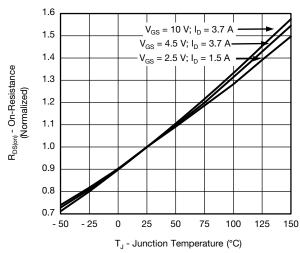
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



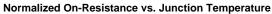
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

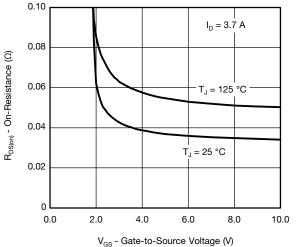




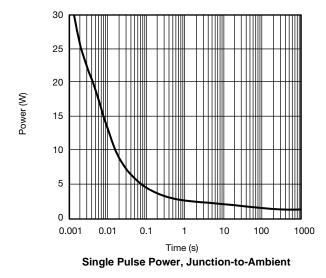


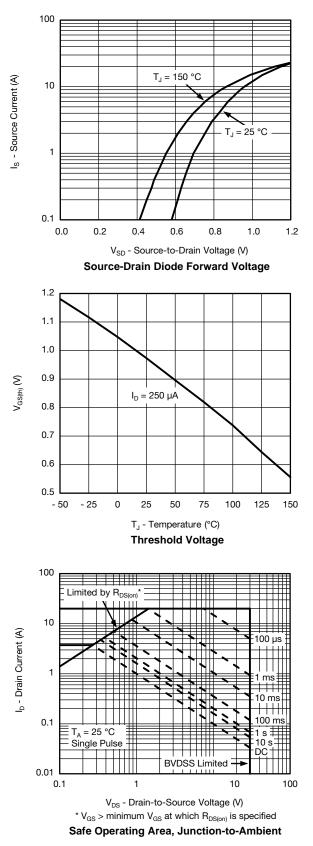
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





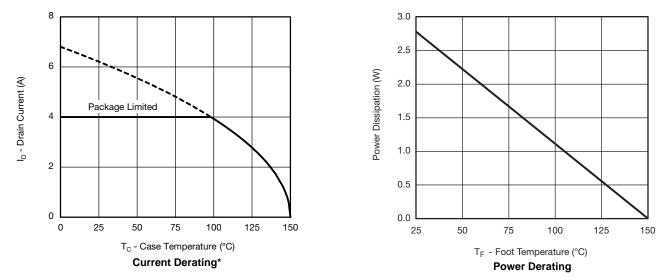








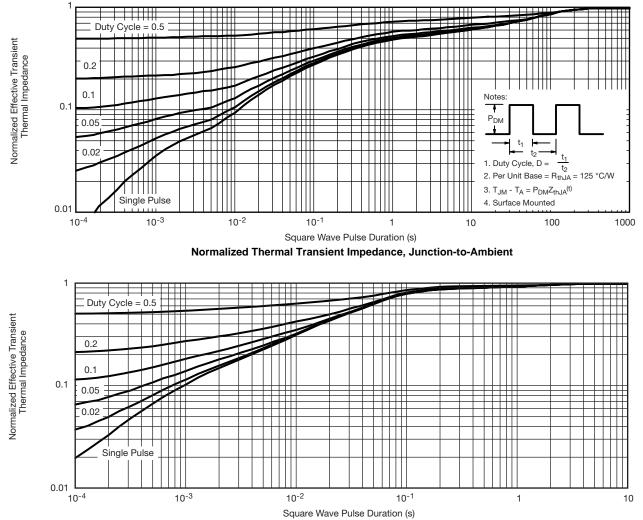
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

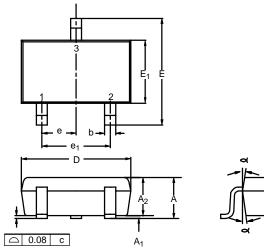


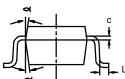
Normalized Thermal Transient Impedance, Junction-to-Foot

AM1340N-T1-PF-VB



SC-70: 3-LEADS



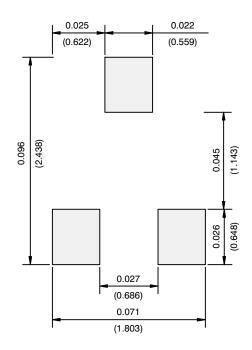


| | MILLIMETERS | | | INCHES | | |
|---|-------------|------|------|----------|-------|-------|
| Dim | Min | Nom | Max | Min | Nom | Max |
| Α | 0.90 | - | 1.10 | 0.035 | - | 0.043 |
| A ₁ | - | - | 0.10 | - | - | 0.004 |
| A ₂ | 0.80 | - | 1.00 | 0.031 | - | 0.039 |
| b | 0.25 | - | 0.40 | 0.010 | - | 0.016 |
| С | 0.10 | - | 0.25 | 0.004 | - | 0.010 |
| D | 1.80 | 2.00 | 2.20 | 0.071 | 0.079 | 0.087 |
| E | 1.80 | 2.10 | 2.40 | 0.071 | 0.083 | 0.094 |
| E ₁ | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 |
| е | 0.65BSC | | | 0.026BSC | | |
| e ₁ | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| a | 7°Nom | | | 7°Nom | | |
| ECN: S-03946—Rev. C, 09-Jul-01 DWG: 5549 | | | | | | |

AM1340N-T1-PF-VB



RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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